## WHAT IS CLAIMED IS:

- 1. A multi-junction solar cell, comprising:
  - a plurality of monolithic cells, each monolithic cell including at least one junction,
    each of the monolithic cells being bonded to at least one other of the monolithic cells
    with a direct wafer bond, wherein the direct wafer bond does not include any
    intervening material between the monolithic cells.
- 2. The multi-junction solar cell of claim 1, wherein the direct wafer bond in achieved by bonding forces between dipoles at a surface of a first one of the monolithic cells and a surface of a second one of the monolithic cells.
- 3. The multi-junction solar cell of claim 1, wherein each of the plurality of monolithic cells has a bandgap that is different from the bandgaps of the other monolithic cells.
- 4. The multi-junction solar cell of claim 1, wherein the multi-junction solar cell has been annealed to strengthen the direct wafer bonds between the plurality of monolithic cells.
- 5. The multi-junction solar cell of claim 1, wherein the multi-junction solar cell includes four junctions.
- 6. The multi-junction solar cell of claim 1, wherein at least one of the plurality of monolithic cells includes more than one junction.

- 7. The multi-junction solar cell of claim 1, wherein each of the plurality of monolithic cells was epitaxially grown on separate substrates.
- 8. The multi-junction solar cell of claim 1, wherein each of the plurality of monolithic cells has a lattice constant that is different than the lattice constants of the other monolithic cells.
- 9. A multi-junction solar cell comprising:
  - a plurality of constituent cells, each constituent cell including at least one junction, the plurality of constituent cells being joined by direct wafer bonds.
- 10. The multi-junction solar cell of claim 9, wherein each of the constituent cells is joined to at least one other of the constituent cells by a direct wafer bond, wherein the direct wafer bond includes no intervening material between the joined constituent cells.
- 11. The multi-junction solar cell of claim 9, wherein each of the plurality of constituent cells is a monolithic cell epitaxially grown on a separate substrate.
- 12. The multi-junction solar cell of claim 9, wherein the direct wafer bonds are achieved by bonding forces between surfaces of adjoining constituent cells.
- 13. The multi-junction solar cell of claim 9, wherein at least one of the plurality of constituent cells includes more than one junction.

14. A method for producing a multi-junction solar cell, comprising:
providing a plurality of monolithic cells, each monolithic cell having at least one junction; and
joining together the plurality of monolithic cells with direct wafer bonds.

- 15. The method of claim 14, further comprising:

  smoothing at least one surface of each monolithic cell prior to joining.
- 16. The method of claim 14, wherein each of the direct wafer bonds does not include any intervening material between surfaces of adjacent monolithic cells.
- 17. The method of claim 14, wherein each of the direct wafer bonds is achieved by bonding forces between dipoles at a surface of one of the monolithic cells and a surface of another of the monolithic cells.
- 18. The method of claim 14, wherein at least one of the plurality of monolithic cells includes more than one junction.
- 19. The method of claim 14, further comprising:
  annealing the multi-junction solar cell to strengthen the direct wafer bonds.

20. The method of claim 14, wherein each of the plurality of monolithic cells has a bandgap that is different from the bandgaps of the other monolithic cells.